

**NEW**

**OMRON**

# Smart Sensors ZS Series

2D CMOS Laser Type



High-precision Displacement Measurement Sensors Bringing Smart Sensors into New Fields.



realizing

# ZS-HL Series

More P.6

Very High-performance Sensors that Support Core Quality from Very Long-range to Extremely Precise Measurements

- Range of models with measuring center distance of 20 to 1,500 mm.
- Achieves maximum resolution of 0.02  $\mu\text{m}$  (0.001  $\mu\text{m}$ ).
- Maximum response speed of 110  $\mu\text{s}$ .
- Parallel output supported.



See

# Highly Advanced Sensing Function



## Record

### Data Storage Unit ZS-DSU ZS-DSU

Ideal for ZS Series Data Logging

Enables onsite high-speed logging of data in external memory (compact flash card) for the Sensor Controller or Multi-Controller.

Effective for building traceability systems, statistical process control (SPC), and much more.

High-speed sampling rate: 150  $\mu\text{s}$   
Powerful support for logging data using various trigger functions.

More P.18

## Control

### Multi-Controller ZS-MDC

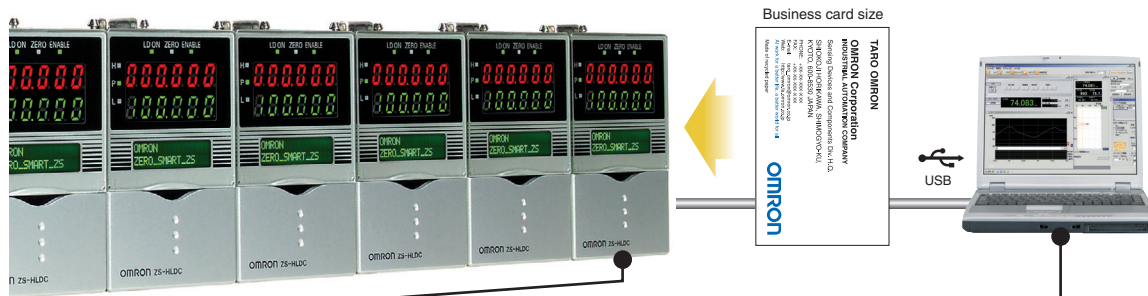
Enables full application of Sensor Controller information.

Transfers data between multi-connected Sensor Controllers and performs high-speed multiprocessing.

Connects to up to nine Sensor Controllers.

More P.17

## Functions in a Compact Package



### Manipulate

**Sensor Controllers ZS-HLDC/LDC**  
Enable maximum sensing performance with fully digital processing.

Culmination of OMRON's lead-edge digital technology. Enables easy utilization of the ultimate in measurement performance.

- Business card size
- USB provided as a standard feature.

More P.12

### Monitor

**SmartMonitor Professional ZS-SW11E V3**  
Setting Software for the ZS Series

Meets a wide range of logging needs. Supports high-speed simultaneous multichannel waveform graphs. Excel macros provided for simple analysis.

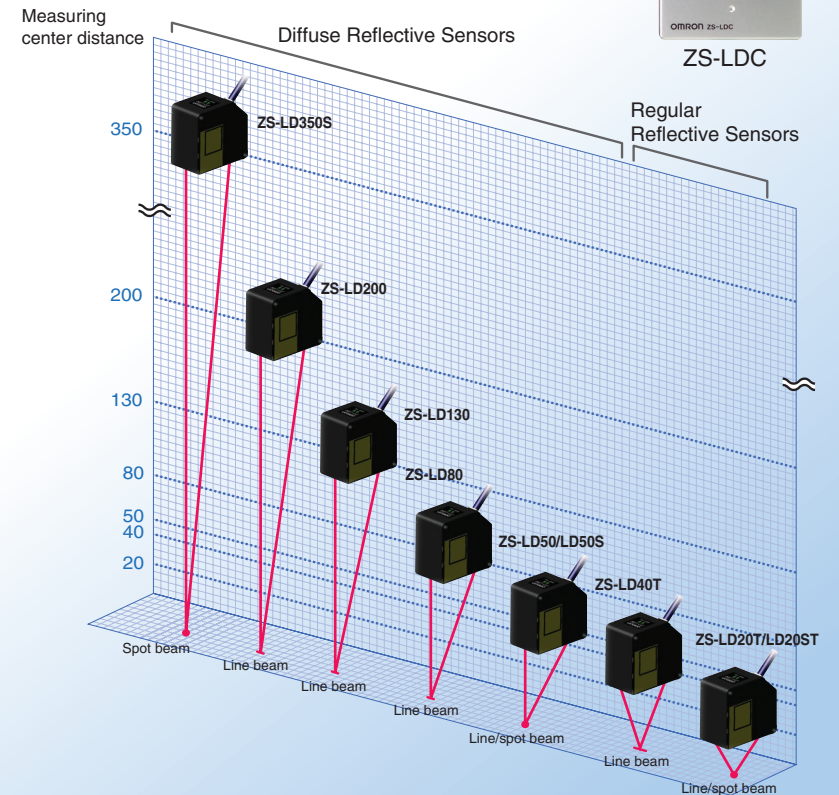
More P.19

## ZS-L Series

More P.14

Standard Sensors Most Suitable for a Variety of High-precision Displacement Measurements, Including Spot Detection, Wide-range Detection, and Long-distance Detection.

- Beam Shapes  
Spot and line beam selection.
- Wide Range of Products  
Long-range, middle-range, and short-range models.



# Main Applications

## High Performance Very High-performance Sensors that Support Core Quality from Very Long-range to Extremely Precise Measurements

ZS-HL Series



**ZS-LD10GT/LD15GT**



Ideal for measuring and controlling dispenser nozzle gaps when applying sealer.

**ZS-HLDS2T**



Ideal for measuring the thickness of silicon or compound semiconductor wafers in polishing and testing processes.

**ZS-HLDS2VT**



Ideal for measuring the potting resin height for electronic components.

**ZS-HLDS5T**



Ideal for measuring liquid gasket (FPIG) application amounts. Prevents defects such as insufficient seal.

**ZS-HLDS10**



Ideal for confirming positioning and repeatability accuracy of XY stages.

**ZS-HLDS60**



Ideal for level detection for liquid crystal coaters and PDP fluorescent substances.

**ZS-HLDS150**



Protruding objects and steps can be measured from a distance for measurement objects that cannot be accessed easily.

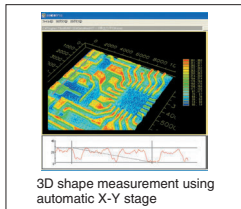
## Standard

ZS-L Series



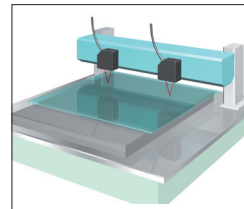
## Standard Sensors Ideal for a Variety of High-precision Displacement Measurements, Including Spot Detection, Wide-range Detection, and Long-distance Detection

**ZS-LD20ST**



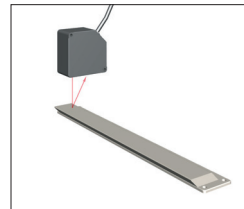
Ideal for measurements requiring discrimination between minute parts or fine shape repeatability.

**ZS-LD40T**



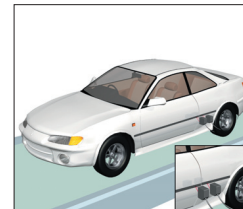
Ideal for measuring glass thickness and nozzle gaps when coating glass with resist or sealer.

**ZS-LD50/LD80**



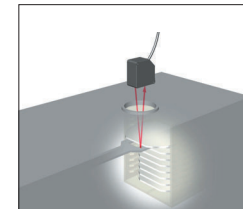
Ideal for measuring the warp of resin blades in copy machine toners.

**ZS-LD200**



Ideal for checking the precision of door installations.

**ZS-LD350S**

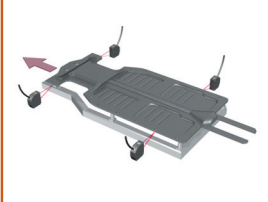


Ideal for checking the flatness of robot arms that transport wafers in load ports.

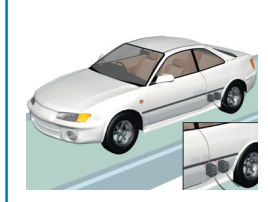
## Applications by Industry

### Automobile and Automotive Parts

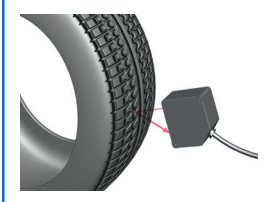
Measuring Car Bodies



Measuring Door Attachment Offsets

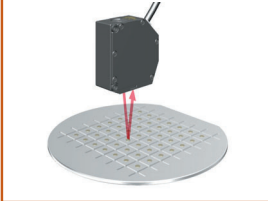


Measuring Tire Exteriors

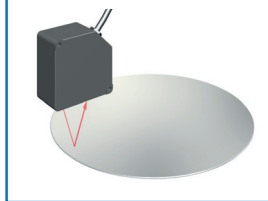


### Semiconductors

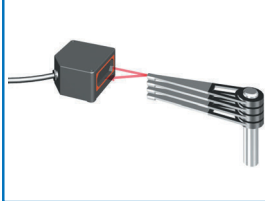
Measuring Electrode Thickness on Compound Semiconductors



Measuring Wafer Warping and Thickness

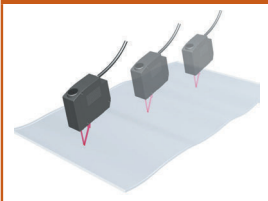


Measuring Arm Inclination

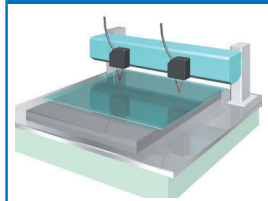


### LCDs and PDPs

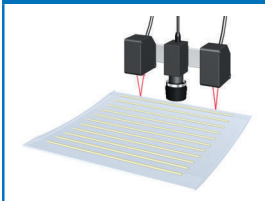
Measuring Glass Undulation



Measuring Glass Surfaces

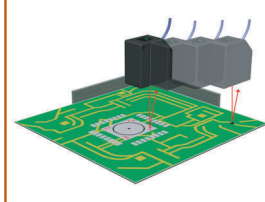


Inspecting Glass Heights (Autofocus)

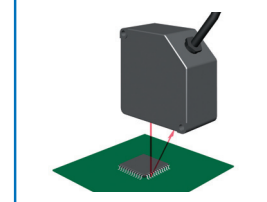


### Electronic Components

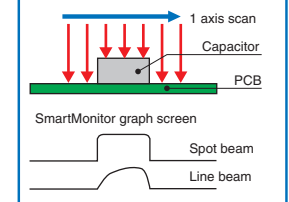
Inspecting Board Heights



Inspecting for Board Coplanarity

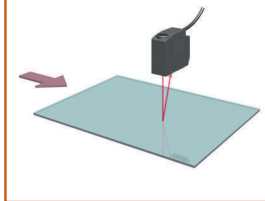


Measuring Shape for Positioning Laminated Ceramics

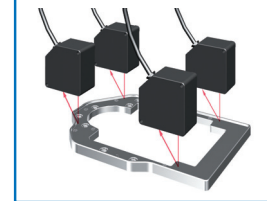


### Household Appliances and Audio-visual

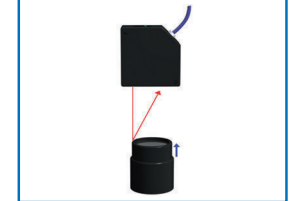
Simultaneous Measuring of Touch Panel Film Thickness and Gap



DVD Chassis Flatness Inspections

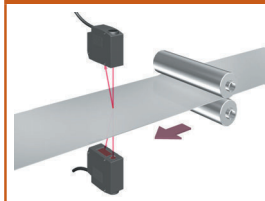


Digital Camera Tube Lens Inspection

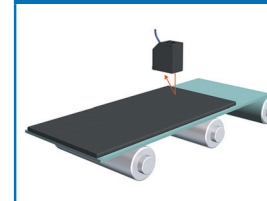


### Rubber, Resin, and Film

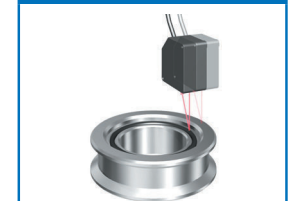
Measuring Electrode Thickness on Dielectrics



Moving Workpieces (Black Rubber)



Measuring Depth of O-Ring Insertion



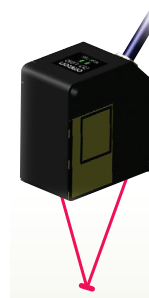
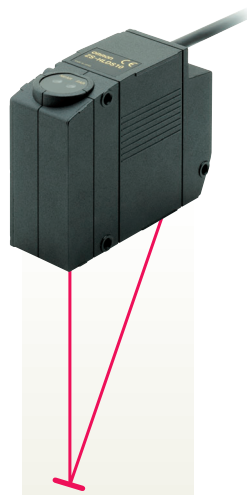
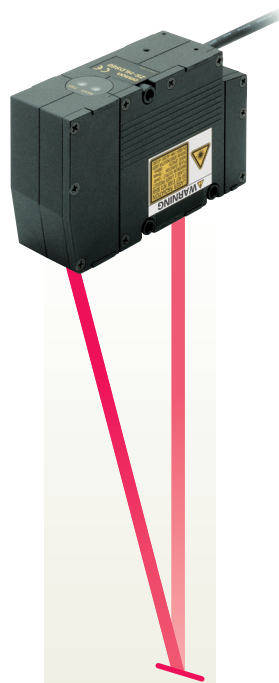
# High-performance Sensors

High grade

## ZS-HL Series Product Lineup 2D CMOS High-end Displacement Sensors

Advanced sensing technology packed into the best Sensor Head for the highest sensing precision

Wide lineup of products from 0.25  $\mu\text{m}$  high-resolution models to 1,500 mm long-range models.

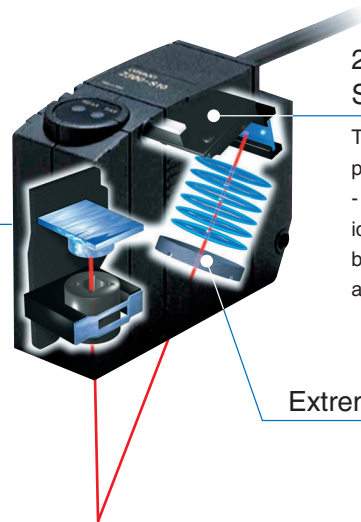


Model	ZS-HLDS150	ZS-HLDS60	ZS-HLDS10	ZS-HLDS5T	ZS-HLDS2T	ZS-HLDS2VT	ZS-LD10GT/LD15GT
Measuring center distance	1500±500 mm	600±350 mm	100±20 mm	50±5 mm	20±1 mm	25±2 mm	10±0.5 mm / 15±0.75 mm
Resolution	500 $\mu\text{m}$	8 $\mu\text{m}$	1 $\mu\text{m}$	0.25 $\mu\text{m}$	0.25 $\mu\text{m}$	0.6 $\mu\text{m}$	0.25 $\mu\text{m}$
Linearity	±0.2%F.S.	±0.07%F.S.	±0.1%F.S.	±0.1%F.S.	±0.05%F.S.	±0.2%F.S.	±0.1%F.S.
Beam shape	1.5 mm × 40 mm	0.3 mm × 16 mm	60 $\mu\text{m}$ × 3.5 mm	30 $\mu\text{m}$ × 1 mm	20 $\mu\text{m}$ × 1 mm	45 $\mu\text{m}$ × 2.2 mm	25 $\mu\text{m}$ × 900 $\mu\text{m}$

## All Models Are Class 2 Lasers.

### Digital Sensing

Totally reliable measurements with completely digital sensing.



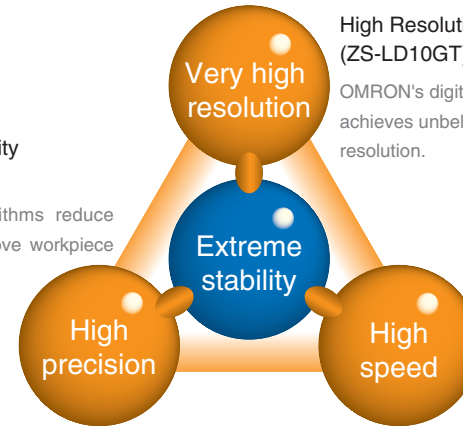
### 2D CMOS Laser Image Sensing Element

The three basics of sensing - precision, speed, and sensitivity - can be balanced because ideal measurement settings can be made for light reception area.

### Extremely Sensitive Lenses

$\pm 0.05\%$  FS Linearity (ZS-HLDS2T)

Unique OMRON algorithms reduce detection error to improve workpiece measurement accuracy.



High Resolution at  $0.001 \mu\text{m}$  (ZS-LD10GT)

OMRON's digital sensing technology achieves unbelievably high resolution.

Super-high-speed Sampling at  $110 \mu\text{s}$  (ZS-HLDS□□/LD□□)

You get exact sensing with superior workpiece following performance. CMOS high-speed data reading accurately catches moving workpieces inline.

## Extreme Stability

### Ideal Size and Stability

#### Head Size

Complete sensing stability with optimum Sensor Head size for best performance and holding mechanism secured at 3 points. (See note.)



◀ ZS-HLDS60/HLDS150

▲ ZS-HLDS2T ▲ ZS-HLDS5T/HLDS10

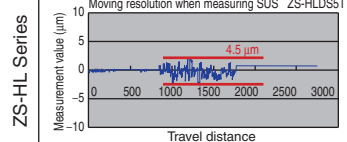
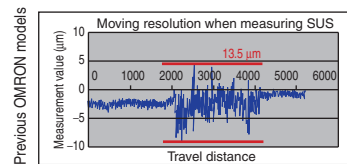


Note: ZS-HLDS2T not applicable.

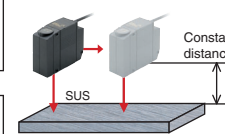
### Superior Moving Resolution

#### Increased Lens Resolution

Moving resolution (error based on workpiece surface position) has been reduced dramatically by optimizing the optical system with increased sensitivity and resolution of the light receiving lenses.



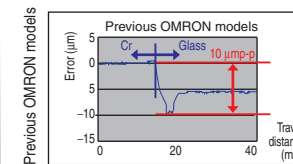
Sampling: 4 ms



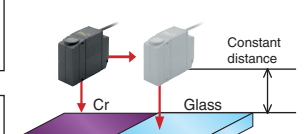
### Reduced Error for Different Materials

#### 2D CMOS

With a CCD, the charge overflows to the next pixel when excessive light is received. This phenomenon does not occur with CMOS, so there are no effects from light fluctuations from different materials or excessive light reception.



Sampling: 4 ms



# High-performance Sensors

High grade

High-performance Sensors

## ZS-HLDS5T/HLDS10 Detect Essentially Any Object

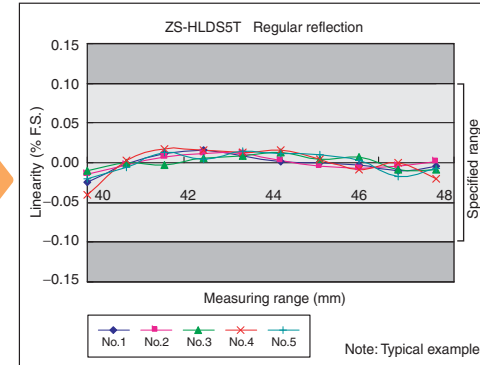
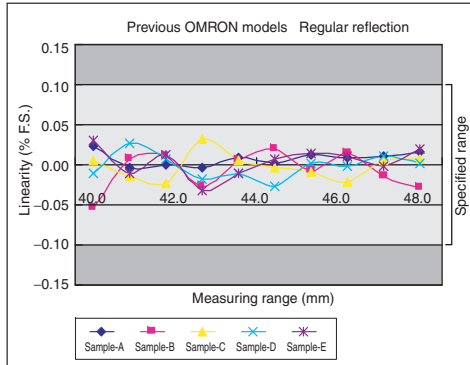
Reduced Variation in Linearity between Different Objects, and Linearity Determines Measurement Accuracy.  
Makes it easier to introduce a variety of detection objects.



Model	<b>ZS-HLDS5T</b>
Measuring center distance	50±5 mm
Resolution	0.25 μm
Linearity	±0.1%F.S.
Beam shape	30 μm × 1 mm

Model	<b>ZS-HLDS10</b>
Measuring center distance	100±20 mm
Resolution	1 μm
Linearity	±0.1%F.S.
Beam shape	60 μm × 3.5 mm

Linearity Characteristic



Measuring Car Body Widths (ZS-HLDS10)



Manage trends by measuring widths of each car model.

## ZS-HLDS60/HLDS150 A Long Range That Handles Essentially Any Installation Site

First 1,500 mm long range sensing in the industry enables measurement of previously impossible points.



Model	<b>ZS-HLDS60</b>
Measuring center distance	600±350 mm
Resolution	8 μm
Linearity	±0.07%F.S.
Beam shape	0.3 mm × 16 mm

Model	<b>ZS-HLDS150</b>
Measuring center distance	1500±500 mm
Resolution	500 μm
Linearity	±0.2%F.S.
Beam shape	1.5 mm × 40 mm

Simple Long-distance Step Measurement



Peak/bottom measurement

Note: This function may not be applicable in bright surroundings.



## ZS-HLDS2VT **NEW**

### Ideal for Measuring the Height and Thickness of Transparent Objects

Tilted and moving workpieces can also be stably measured.



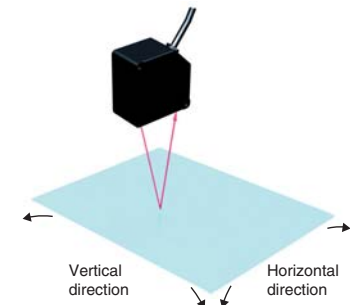
Model	<b>ZS-HLDS2VT</b>
Measuring center distance	25±2 mm
Resolution	0.6 μm
Linearity	±0.2%F.S.
Beam shape	45 μm × 2.2 mm

A special aspherical lens was developed for the ZS-HLDS2VT, and the design of the optical structure was optimized for regular-reflective workpieces. This has greatly increased the allowable degree of tilt and improved stability for measuring transparent and regular-reflective workpieces.



Aspherical lens (newly developed)

#### Angle Characteristics



# High-performance Sensors

High grade

## ZS-HLDS2T/ZS-LD10GT/LD15GT

### The Only Way to Very High-precision Measurements

Superior Features for Semiconductor Wafer, Glass, and Other Measurements Requiring Precision



Model	<b>ZS-HLDS2T</b>
Measuring center distance	20±1 mm
Resolution	0.25 μm
Linearity	±0.05%F.S.
Beam shape	20 μm × 1 mm

Simultaneous Measuring of Touch Panel Film Thickness and Gap



Simultaneous measurement of transparent object thickness and gap

An unbelievable stationary measurement precision of 0.25 μm, the highest in this product class.



#### Ideal for Measuring Nozzle Gaps!

- Reduced pattern influence for moving measurement, the best in the moving resolution industry.
- Possible to match nozzle drip point and measurement point then measure.
- Sensor Head with separate light emission and reception in one unit to create nozzle space.

Model	<b>ZS-LD10GT/LD15GT</b>
Measuring center distance	10±0.5 mm/15±0.75 mm
Resolution	0.25 μm
Linearity	±0.1%F.S.
Beam shape	25 × 900 μm



Height Control of Sealant Dispensers



Inspection of Disk Play on HDD Motor Rotating Plate



Measures amplitude undulations of 5 μm.

## Technology

With OMRON's sensing technology and newly developed algorithms, stable, high-precision measurement is possible of workpieces that were difficult to measure using laser displacement meters due to laser light penetration, transmission, excessive reflection, or insufficient light.

Mechanisms for Stable Measurement **Patent Pending**

### No more errors due to reflection coefficients between glass gaps

Stable measurement by adding received light waveform in 2D image and digital zoom processing.



Measurement cycle time 1/8 better than previous models with addition of received light waveform captured by 2D CMOS and simultaneous measurement of front and back glass surfaces with separate sensitivities.

Mechanisms for Stable Measurement **Patent Pending**

### No more errors due to workpiece reflection coefficients.

Stable measurement using laser power algorithms that can be adjusted to any value.

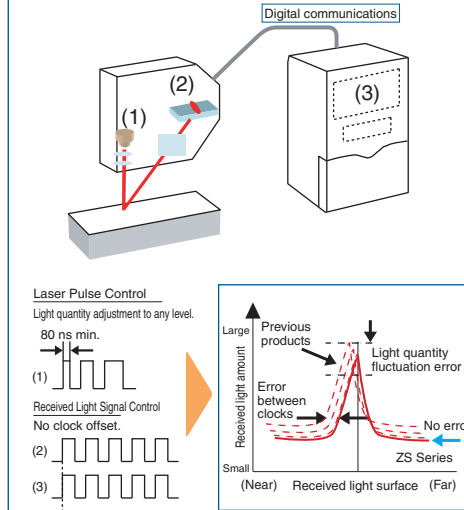


Light quantity adjustment algorithms have evolved for stable measurement of a variety of measurement objects. Even if the workpiece status changes suddenly, the sensitivity can compensate at any level so there is no measurement error from sensitivity switching.

Mechanisms for High Resolution **Patent Pending**

### No more resolution errors.

Digital processing technology between the Sensor and Controller provides high resolution.

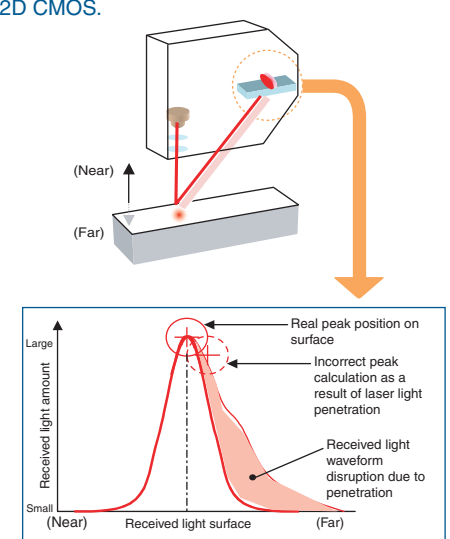


High-speed digital communications (LVDS) used between Sensor and Controller. Image signal stabilizes because the clock error between the control signal from the Controller and the light reception device disappears. Optimum light quantity adjustment is possible with laser power algorithms that can be adjusted to any level, which facilitates super high resolution.

Mechanisms for Stable Measurement

### No more error due to penetration.

Stable measurements are achieved by correctly recognizing the light reception distribution on the 2D CMOS.



Real surface displacement detected by eliminating penetration effects for PCBs, plastic, and other workpieces penetrated by laser light.

# High-performance Sensors

High grade

## Sensor Controllers ZS-HLDC (Multitasking)

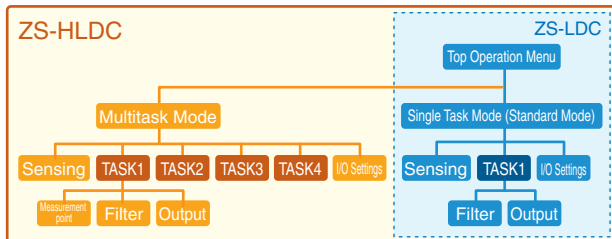
Enables maximum sensing performance with fully digital processing and multitasking functions.

A controller the size of a business card filled with OMRON's leading-edge digital technology.

Enables easy utilization of the ultimate in measurement performance.



### Outline of Functions

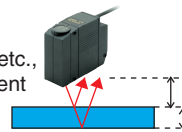


### High-performance Sensing (Multitasking)

Simultaneous Measurement and Output of Up to 4 Features

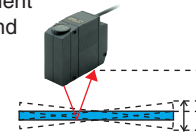
- When simultaneous measurement of distance to glass, glass thickness, gap, etc., required in glass measurement applications

Setting example  
 ■ Task 1: Average  
 ■ Task 2: Thickness



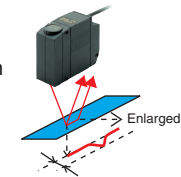
- For simultaneous measurement of HDD surface deflection and distance to HDD surface

Setting example  
 ■ Task 1: Average, Average hold  
 ■ Task 2: Average, Point-to-point hold



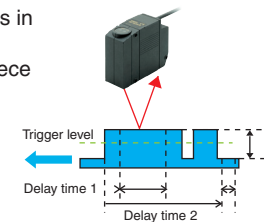
- For detection of small recesses and protrusions in measurement location

Setting example  
 ■ Task 1: Step



- For measurement of steps in different locations with moving Sensor or workpiece

Setting example  
 ■ Task 1: Average  
 Self-down trigger  
 Average hold  
 With delay  
 ■ Task 2: Average  
 Average hold  
 With delay  
 ■ Task 3: Calculation (Task 2 - Task 1)

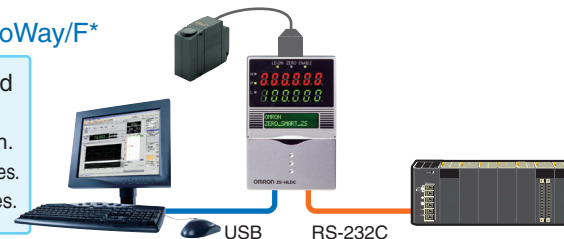


Simultaneous Control in 2 Systems of Data Confirmation and Analysis and Data Collection, Control, and Changeovers

### Control Using CompoWay/F\*

Data Confirmation and Analysis

- Checks sensing screen.
- Checks measurement values.
- Logs measurement values.



\* OMRON's unique communications protocol.

### Control Using No-protocol Communications

Data collection, control, and changeovers

- Gets measurement results.
- Resets to zero.
- Switches banks.

Improved Total Cycle Time with 1-second High-speed Bank Switching

## Easy Sensing with an HMI That Couldn't Be Easier to Use (Common Functions)

### Information at the Touch of a Button

In RUN (measurement) Mode, measured values and information are displayed using 2 rows of 8-segment LEDs. The large LED display improves visibility. Measurement information includes the threshold, current, resolution, and received light amount and is available with simple key operations. LCD screens can be customized to change the display of desired information to easier-to-understand terminology.

RUN  
(measurement mode)

Example of  
Display Customization



Mount to DIN Track or  
directly to control  
panels.

Patent Pending



Panel Mounting Adapter (Option, Sold Separately)

### Set Sensing Directly Patent Pending

In FUN (setting) Mode, setting menus are displayed on the 2 rows of the LCD. Easy-to-understand guidance simplifies setting the many display capabilities of the LCD. Function keys correspond to displayed menu items for intuitive setting of measurement conditions and other parameters. You can also easily switch between Japanese and English displays. Communication with the operator is better than ever before.



### Connect directly to a PC using USB.

USB 2.0 and RS-232C provided as standard features. LVDS, a new-generation digital high-speed communications interface, is used between the Sensor Head and Controller, an industry first. If USB is used to connect to the computer, high-speed all digital measurement data transfer is possible. Firmware can be updated easily using the SmartMonitor WarpEngine.



USB Connection



## ZS-LDC Single Task Controller

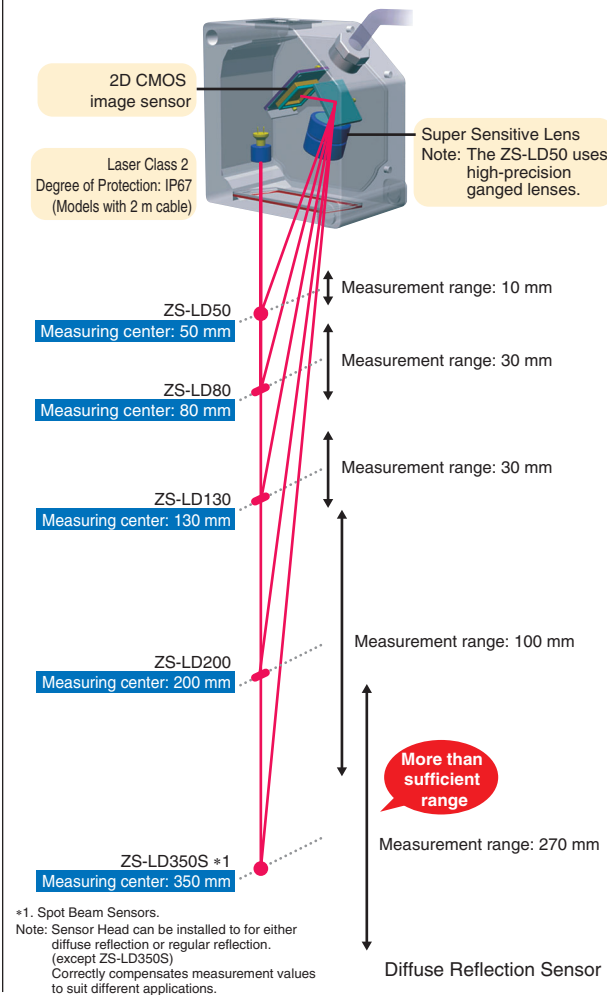
Simple Operation  
Reasonable Price

## ZS-L Series Product Lineup 2D CMOS Low-end Displacement Sensors

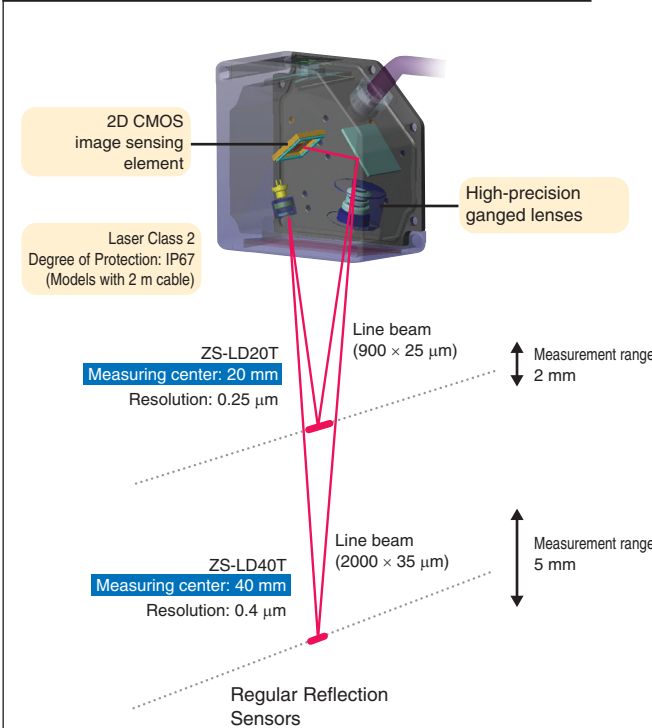
Advanced sensing technology packed into the smallest Sensor Heads in this class.

- Smallest size in this class (65 × 65 mm)
- Uniform Sensor Head size
- Line/spot beam type
- Detects black rubber, mirror, and transparent workpieces

### ZS-LD50/LD80/LD130/LD200/LD350S

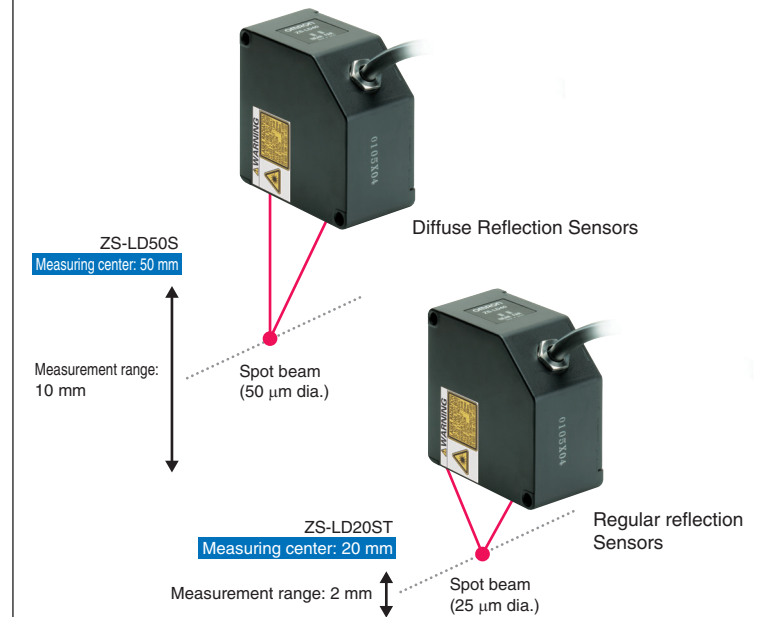


### ZS-LD20T/LD40T



### ZS-LD20ST/LD50S

#### Spot Beam Sensors



## Stable Measurements for PCBs, Black Resin, and Metal

All you need to do is select the proper mode to achieve stable sensing of PCBs, resins, black rubber, and other light-penetrating workpieces (these could not be easily handled with previous reflective laser displacement meters.)

### ZS-LD80

Measuring the Shape of Black Resin Workpieces



Complete measurement data will be obtained at angles of up to 40°.

### ZS-LD50

Measuring the Shape PCB Surfaces



PCB shapes can be measured without burs or waveform disruptions.

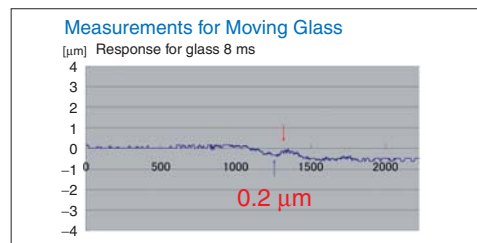
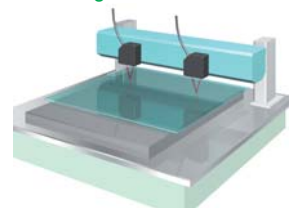
## Stable Measurements for Glass

Stably measure height and undulations in transparent, coated, or colored glass on work tables. Stable detection at 40 mm with a line beam of 2 mm.

A 2-mm line beam reduces the influence of black and white patterns on granite work tables to achieve stable measurements.

### ZS-LD40T

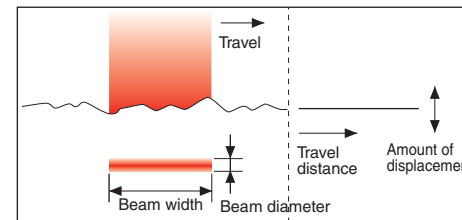
Measuring Glass Surfaces



Ideal for measuring glass thickness and slit nozzle gaps when coating glass with resist or sealer.

## Line Beam Sensors for Emphasis on Stable Measurement

Line beams produce an averaging affect that is less likely to be affected by surface irregularities, creating stable measurements. Ideal for stable measurements that do not rely on the surface of the target workpiece.



Line Beam sensors	ZS-LD20T	ZS-LD40T	ZS-LD50	ZS-LD80	ZS-LD130	ZS-LD200
Beam diameter	25 μm	35 μm	60 μm	60 μm	70 μm	100 μm
Beam width	0.9 mm	2 mm	0.9 mm	0.9 mm	0.6 mm	0.9 mm

## Spot Beam Sensors Ideal for Minute Workpieces and Shape Measurement

Ideal for measurements requiring minute shape repeatability while matching laser beam position with a minute target measurement area.



Spot Beam sensors	ZS-LD20ST	ZS-LD50S	ZS-LD350S
Beam width	25 μm dia.	50 μm dia.	240 μm dia.

## Easy Sensing with an HMI That Couldn't Be Easier to Use

- Just select High-precision Mode to stably measure black rubber.
- Just select Penetration Mode to stably measure PCBs or black resin.

### Set Sensing Directly

FUN (setting mode)

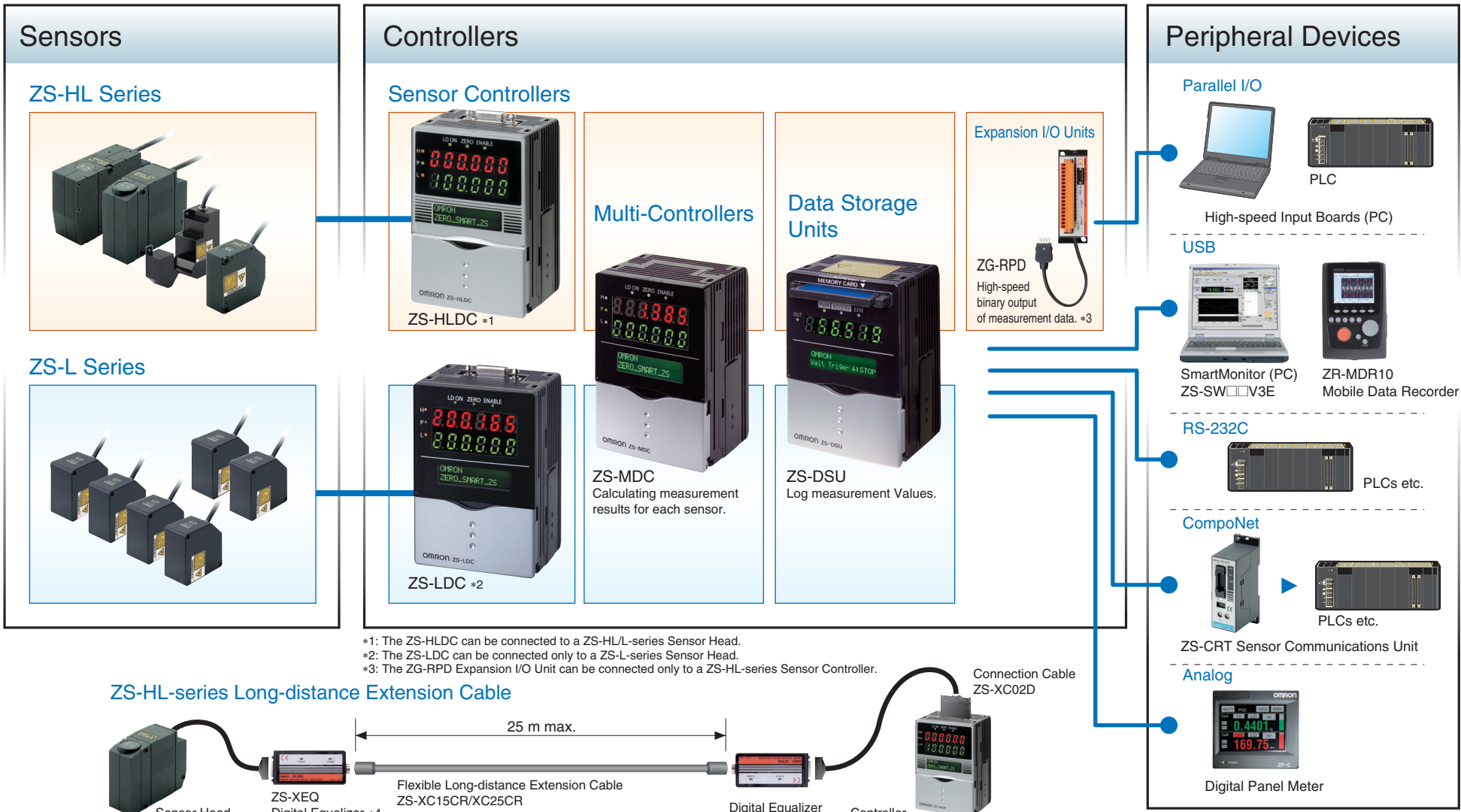


Direct setting with function keys.

# Expansion Units

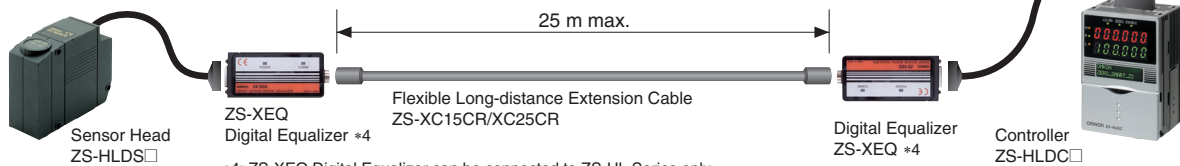
Enhancing unit

## System Configuration



\*1: The ZS-HLDC can be connected to a ZS-HL-series Sensor Head.  
 \*2: The ZS-LDC can be connected only to a ZS-L-series Sensor Head.  
 \*3: The ZG-RPD Expansion I/O Unit can be connected only to a ZS-HL-series Sensor Controller.

### ZS-HL-series Long-distance Extension Cable



\*4: ZS-XEQ Digital Equalizer can be connected to ZS-HL Series only.

Expansion Units



## Multi-Controller ZS-MDC

### Centralized Controller Information Calculations

Transfers data between multi-connected Controllers and performs high-speed multiprocessing.

#### High-speed Connections for Up To 9 Controllers

See the difference in applications requiring multipoint measurement, such as thickness, steps, and flatness measurements. Connect up to 9 Controllers with the fastest high-speed bus in the industry. Digital processing prevents data dropouts to provide the capability to measure exactly what is seen.

Sampling speed with 3 Controllers connected: 110  $\mu$ s, Sampling speed with 9 Controllers connected: 380  $\mu$ s

Note: When using communications commands.

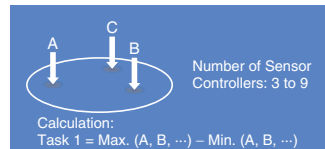


Expansion Units

#### Processing Enabled by the Multi-Controller

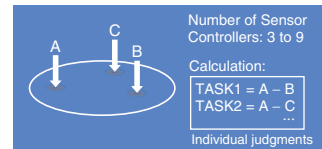
##### Flatness Calculations

Calculating the difference between the maximum and minimum values.



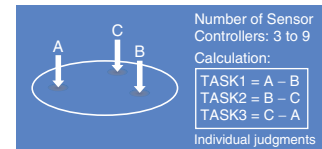
##### Reference Step Calculations

Calculating the difference between a reference point (A) and other points.



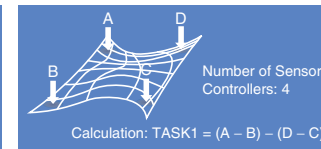
##### Relative Step Calculations

Calculating the difference between all points.



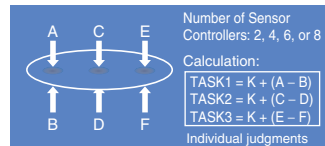
##### Twisting Calculations

Calculating twisting between opposing sides.



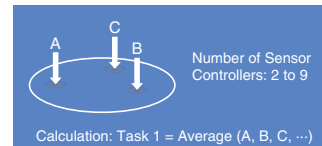
##### Multipoint Thickness Calculations

Calculating the difference between pairs of points.



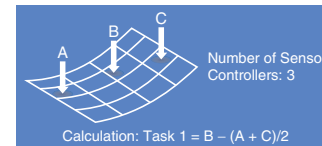
##### Average Height Calculations

Calculating the average surface height.



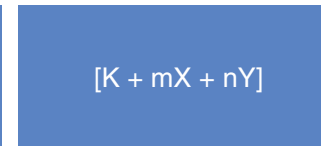
##### Warp Calculations

Calculating warping of selected sides



##### User-set Calculations

Formulas can be flexibly set.



Multi-calculations of Data

Multipoint measurement

High-speed data transfer

# Expansion Units

Enhancing unit

## Data Storage Unit ZS-DSU

Logging Software for Onsite Installed



Efficiently stores sensing data using a variety of logging functions.  
 High-speed, long term logging settings can be used to precisely process the required sensing data, which can be reliably and completely collected using USB and an all-digital bus.  
 Sensor setting data can also be stored.  
 Data for up to 128 banks can be stored and transferred to the Master Unit for changeovers.

- High-speed sampling rate: 150  $\mu$ s max.
- Powerful support for logging data using various trigger functions.

Config-uration	Number of connectable Controllers	10 max. (ZS-MDC: 1, ZS-HLDC/LDC: 9 max.)
	Connectable Controllers	ZS-HLDC□, ZS-LDC□, ZS-MDC□
Perform-ance	Data resolution	32 bits
	Sampling rate	<ul style="list-style-type: none"> <li>• Shortest high-speed logging mode (One-shot Mode) *1</li> <li>• Long-term logging mode (Repeat Mode) *2</li> <li>• Sampling period: 10 ms to 1 h (at 1-ms intervals)</li> </ul>
Func-tions	Trigger functions	Start and end triggers can be set separately. External trigger/data trigger (self-trigger) Time triggers
	Other functions	<ul style="list-style-type: none"> <li>• External bank function</li> <li>• Alarm output function</li> <li>• Saved data format customization function</li> <li>• Time function (timestamps)</li> </ul>
Software (included)		<ul style="list-style-type: none"> <li>• CSV file generation Software</li> <li>• Excel macros for simple analysis (Equivalent to software provided with SmartMonitor Professional.)</li> </ul>



Data Storage Unit ZS-DSU

Multipoint data collection

Traceability

Changeover Unit

\*1) For One-shot Mode

• Connected to ZS-LDC

Number of channels	Min. sampling interval	Longest logging time
1	150 $\mu$ s	10 min
2	200 $\mu$ s	6.5 min
4	350 $\mu$ s	5.5 min
9	650 $\mu$ s	4.5 min

Typical examples

\*2) For Repeat Mode (Logging time depends on capacity of Memory Card.)

• Example for 64-MB Memory Card

Number of channels	Min. sampling interval	Longest logging time
1	10 ms	20 h
2	10 ms	10 h
4	10 ms	5 h
9	10 ms	2 h

Typical examples

• Connected to ZS-MDC

Number of channels	Min. sampling interval	Longest logging time
1	350 $\mu$ s	20 min
2	400 $\mu$ s	12 min
4	500 $\mu$ s	8 min
9	700 $\mu$ s	5 min

Typical examples

## Setting Software for ZS Series SmartMonitor V3 Professional ZS-SW11V3E

Use a Computer for Everything from Ideal ZS Settings to Powerful Support of Data Collection and Analysis.  
Easy Settings Using USB.

### More Powerful Setting Support

The CMOS light reception image and the received light waveform can be displayed. The real power of the SmartMonitor is seen when measuring transparent objects and other workpieces that create multiple received light waveforms.

#### ●Received Light Monitor



### High-speed simultaneous multichannel waveform graphs.

High-speed display: 2-ms interval at max. speed (see note);  
Simultaneous multichannel waveform display: Up to 9 waveforms can be displayed.

Note: Data may be skipped, depending on the computer system. Use a computer that meets the recommended system requirements.

#### ●Multi-channel Waveform Display



### Meets a wide range of logging needs.

Log measurement results at various times to leave judgment and inspection results.

The fastest sampling interval is 500 μs (see note).

Note: Data may be skipped, depending on the computer system.

Use a computer that meets the recommended system requirements.

#### ●Logging



### Excel macro provided for simple analysis.

Data collected by logging can be processed with an Excel macro using filters, slope compensation, filter median transitions, differentiation, integration, and arithmetic functions and then used for nominal judgments and other determinations.

#### ●Analysis



Recommended System Requirements  
SmartMonitor Professional  
OS: Windows 2000/XP  
CPU: Pentium III 850 MHz or greater (2 GHz min. recommended.)  
Memory: 128 MB min. (256 MB min. recommended)  
Available hard disk space: 50 MB min.  
Display screen: 800 × 600 dots, High Color (16 bits) min.  
(1,024 × 768 dots, True Color (32 bits) min. recommended)

Note: If the recommended system requirements are not met, data may be interrupted and waveforms not displayed correctly when using the logging, high-speed graph drawing, and multi-channel waveform drawing functions.

SmartAnalyzer Macro Edition  
For Microsoft Excel Macro Programming  
Microsoft Excel 2000 or later required.

# Ratings and Specifications

## Specification

## Ordering Information Smart Sensor

### ZS-HL-series Sensor Heads

Optical system	Sensing distance	Beam shape	Beam diameter	Resolution (see note 1.)	Model
Regular Reflective Models	20±1 mm	Line beam	1.0 mm × 20 μm	0.25 μm	ZS-HLDS2T
	25±2 mm	Line beam	2.2 mm × 45 μm	0.6 μm	ZS-HLDS2VT
Diffuse Reflective Models	50±5 mm	Line beam	1.0 mm × 30 μm	0.25 μm	ZS-HLDS5T
	100±20 mm	Line beam	3.5 mm × 60 μm	1 μm	ZS-HLDS10
	600±350 mm	Line beam	16 mm × 0.3 mm	8 μm	ZS-HLDS60
	1500±500 mm	Line beam	40 mm × 1.5 mm	500 μm	ZS-HLDS150

Note 1: Refer to the table of ratings and specifications for details.

2: Specify the cable length when ordering.

### ZS-HL-series Sensor Heads (For Nozzle Gaps)

Optical system	Sensing distance	Beam shape	Beam diameter	Resolution (see note 1.)	Model
Regular Reflective Models	10±0.5 mm	Line beam	900 × 25 μm	0.25 μm	ZS-LD10GT
	15±0.75 mm	Line beam	900 × 25 μm	0.25 μm	ZS-LD15GT

Note 1: Refer to the table of ratings and specifications for details.

2: Specify the cable length when ordering.

### ZS-L-series Sensor Heads

Optical system	Sensing distance	Beam shape	Beam diameter	Resolution (see note 1.)	Model
Regular Reflective Models	20±1 mm	Line beam	900 × 25 μm	0.25 μm	ZS-LD20T
		Spot beam	25 μm dia.	0.25 μm	ZS-LD20ST
	40±2.5 mm	Line beam	2000 × 35 μm	0.25 μm	ZS-LD40T
Diffuse Reflective Models	50±5 mm	Line beam	900 × 60 μm	0.8 μm	ZS-LD50
		Spot beam	50 μm dia.	0.8 μm	ZS-LD50S
	80±15 mm	Line beam	900 × 60 μm	2 μm	ZS-LD80
	130±15 mm	Line beam	600 × 70 μm	3 μm	ZS-LD130
	200±50 mm	Line beam	900 × 100 μm	5 μm	ZS-LD200
	350±135 mm	Spot beam	240 μm dia.	20 μm	ZS-LD350S

Note 1: No. of samples to average: 128 when set to High-precision Mode.

2: Specify the cable length when ordering.

### ZS-HL-series Sensor Controllers

Shape	Supply voltage	Control outputs	Model
	24 VDC	NPN outputs	ZS-HLDC11
		PNP outputs	ZS-HLDC41

### ZS-L-series Sensor Controllers

Shape	Supply voltage	Control outputs	Model
	24 VDC	NPN outputs	ZS-LDC11
		PNP outputs	ZS-LDC41

### Multi-Controllers

Shape	Supply voltage	Control outputs	Model
	24 VDC	NPN outputs	ZS-MDC11
		PNP outputs	ZS-MDC41

### Data Storage Units

Shape	Supply voltage	Control outputs	Model
	24 VDC	NPN outputs	ZS-DSU11
		PNP outputs	ZS-DSU41

## Accessories (Sold Separately)

### Controller Link Unit

Shape	Model
	ZS-XCN

### Panel Mount Adapter

Shape	Model	
	ZS-XPM1	For 1st Controller
	ZS-XPM2	For expansion (from 2nd Controller on)

### RS-232C Cables

Connected to	Model	Qty
Personal computer (2 m)	ZS-XRS2	1
PLC/PT (2 m)	ZS-XPT2	1

### Extension Cables for Sensor Heads

Cable length	Model	Qty
1 m	ZS-XC1A	1
4 m	ZS-XC4A	1
5 m	ZS-XC5B (*1, *2)	1
8 m	ZS-XC8A	1
10 m	ZS-XC10B (*1)	1

\*1. Up to two ZS-XC□B Cables can be connected. (22 m max.)

\*2. A Robot Cable (ZS-XC5BR) is also available.


### Long Extension Cables for Sensor Heads (Used with a Digital Equalizer for ZS-HL Series)

Name	Model	Qty
Digital Equalizer (Relay)	ZS-XEQ	1
Extension Cable (long distance, flexible 15 m cable)	ZS-XC15CR	1
Extension Cable (long distance, flexible 25 m cable)	ZS-XC25CR	1
Digital Equalizer Connection Cable (0.2 m)	ZS-XC02D	1

### Logging Software

Name	Model
SmartMonitor Professional	ZS-SW11V3E

### Realtime Parallel Output Unit (for ZS-HL Series)

Shape	Control outputs	Model
	NPN outputs	ZG-RPD11
	PNP outputs	ZG-RPD41

### CompoNet-compatible Sensor Communications Unit.

Shape	Model
	ZS-CRT

### Memory Cards

Model	Capacity
F160-N128S	128 Mbytes
F160-N256S	256 Mbytes

# Ratings and Specifications

## ZS-HL/L-series Sensor Controllers

Item	Model	ZS-HLDC11/LDC11	ZS-HLDC41/LDC41	
No. of samples to average		1, 2, 4, 8, 16, 32, 64, 128, 256, 512, 1,024, 2,048, or 4,096		
Number of mounted Sensors		1 per Sensor Controller		
External interface	Connection method	Serial I/O: connector, Other: pre-wired (Standard cable length: 2 m)		
	Serial I/O	USB 2.0	1 port, Full Speed (12 Mbps max.), MINI-B	
		RS-232C	1 port, 115,200 bps max.	
	Output	Judgment output	HIGH/PASS/LOW 3 outputs NPN open collector, 30 VDC, 50 mA max., residual voltage 1.2 V max.	HIGH/PASS/LOW: 3 outputs PNP open collector, 50 mA max., residual voltage 1.2 V max.
		Linear output	Selectable from 2 types of output, voltage or current (selected by slide switch on bottom). • Voltage output: -10 to 10 V, output impedance: 40 Ω • Current output: 4 to 20 mA, maximum load resistance: 300 Ω	
Inputs	Laser OFF, ZERO reset timing, RESET	ON: Short-circuited with 0 V terminal or 1.5 V or less OFF: Open (leakage current: 0.1 mA max.)	ON: Short-circuited to supply voltage or within 1.5 V of supply voltage. OFF: Open (leakage current: 0.1 mA max.)	
Functions		Display: Measured value, threshold value, voltage/current, received light amount, and resolution/terminal block output *2 Sensing: Mode, gain, measurement object, head installation Measurement point *1: Average, peak, bottom, thickness, step, and calculations Filter: Smooth, average, and differentiation Outputs: Scaling, various hold values, and zero reset I/O settings: Linear (focus/correction), judgments (hysteresis and timer), non-measurement, and bank (switching and clear) *2 System: Save, initialization, measurement information display, communications settings, key lock, language, and data load Task: ZS-HLDC□1: Single task or multitask (up to 4) ZS-LDC□1: Single task		
Status indicators		HIGH (orange), PASS (green), LOW (orange), LDON (green), ZERO (orange), and ENABLE (green)		
Segment display	Main digital	8-segment red LED, 6 digits		
	Sub-digital	8-segment green LEDs, 6 digits		
LCD		16 digits x 2 rows, Color of characters: green, Resolution per character: 5 x 8 pixel matrix		
Setting inputs	Setting keys	Direction keys (UP, DOWN, LEFT, and RIGHT), SET key, ESC key, MENU key, and function keys (1 to 4)		
	Slide switch	Threshold switch (2 states: High/Low), mode switch (3 states: FUN, TEACH, and RUN)		
Power supply voltage		21.6 V to 26.4 VDC (including ripple)		
Current consumption		0.5 A max. (when Sensor Head is connected)		
Ambient temperature		Operating: 0 to 50°C, Storage: -15 to +60°C (with no icing or condensation)		
Ambient humidity		Operating and storage: 35% to 85% (with no condensation)		
Degree of protection		IP20 (IEC60529)		
Materials		Case: Polycarbonate (PC)		
Cable length		2 m		
Weight		Approx. 280 g (excluding packing materials and accessories)		
Accessories		Ferrite core (1), instruction sheet		

\*1. Can be used with ZS-HLDC□1 when Multitask Mode selected.

\*2. Terminal block output is a function of the ZS-HLDC□1.

## Ratings and Specifications

### ZS-HL-series Sensor Heads

Item	Model	ZS-HLDS2T	ZS-HLDS2VT	ZS-HLDS5T	ZS-HLDS10	ZS-HLDS60	ZS-HLDS150	
Applicable Controllers		ZS-HLDC series						
Optical system		Regular reflection	Diffuse reflection	Regular reflection	Diffuse reflection	Regular reflection	Diffuse reflection	
Measuring center distance		20 mm	5.2 mm	25 mm	50 mm	44 mm	100 mm	
Measuring range		±1 mm	±1 mm	±2 mm	±5 mm	±4 mm	±20 mm	
Light source		Visible semiconductor laser (wavelength: 650 nm, 1 mW max., JIS Class 2)				Visible semiconductor laser (wavelength: 658 nm, 1 mW max., JIS Class 2)		
Beam shape		Line beam						
Beam diameter *1		1.0 mm × 20 μm	2.2 mm × 45 μm	1.0 mm × 30 μm	3.5 mm × 60 μm		16 × 0.3 mm (at 500 mm)	
Linearity *2		±0.05%F.S.	±0.2%F.S.	±0.1%F.S.			±0.07%F.S. (250 to 750 mm), ±0.1%F.S. (750 to 950 mm)	
Resolution *3		0.25 μm (No. of samples to average: 256)	0.6 μm (No. of samples to average: 128)	0.25 μm (No. of samples to average: 512)	1 μm (No. of samples to average: 64)		8 μm (No. of samples to average: 64 at 250 mm), 40 μm (No. of samples to average: 64 at 600 mm)	
Temperature characteristic *4		0.01%F.S./°C	0.1%F.S./°C	0.01%F.S./°C				
Sampling cycle		110 μs (High-speed Mode), 500 μs (Standard Mode), 2.2 μs (High-precision Mode), 4.4 μs (High-sensitivity Mode)						
LED Indicators	NEAR indicator	Lights near the measuring center distance, and closer than the measuring center distance inside the measuring range. Flashes when the measurement target is outside of the measuring range or when the received light amount is insufficient.						
	FAR indicator	Lights near the measuring center distance, and farther than the measuring center distance inside the measuring range. Flashes when the measurement target is outside of the measuring range or when the received light amount is insufficient.						
Operating ambient illumination		Illumination on received light surface: 3000 lx or less (incandescent light)				Illumination on received light surface: 1000 lx or less (incandescent light)	Illumination on received light surface: 500 lx or less (incandescent light)	
Ambient temperature		Operating: 0 to 50°C, Storage: -15 to 60°C (with no icing or condensation)						
Ambient humidity		Operating and storage: 35% to 85% (with no condensation)						
Degree of protection		IP64	IP67	Cable length 0.5 m: IP66, cable length 2 m: IP67			IP66 *5	
Materials		Case: Aluminum die-cast, Front cover: Glass						
Cable length		0.5 m, 2 m	2 m	0.5 m, 2 m				
Weight		Approx. 350 g		Approx. 600 g			Approx. 800 g	
Accessories		Laser labels (1 each for JIS/EN), ferrite cores (2), insure locks (2), instruction sheet						

\*1. Defined as  $1/e^2$  (13.5%) of the center optical intensity at the actual measuring center distance (effective value). The beam diameter is sometimes influenced by the ambient conditions of the workpiece, such as leaked light from the main beam.

\*2. This is the error in the measured value with respect to an ideal straight line.  
Linearity may change according to the workpiece.  
The following options are available.

Model	Diffuse reflection	Mirror reflection
ZS-HLDS2T	SUS block	Glass
ZS-HLDS2VT	---	Glass
ZS-HLDS5T	White alumina ceramic	Glass
ZS-HLDS10	White alumina ceramic	---
ZS-HLDS60/HLDS150	White alumina ceramic	---

\*3. This is the peak-to-peak displacement conversion value in the displacement output at the measuring center distance in high-precision mode when the number of samples to average is set to within the graph.  
The maximum resolution at 250 mm is also shown for the ZS-HLDS60. The following options are available.

Model	Diffuse reflection	Mirror reflection
ZS-HLDS2T	SUS block	Glass
ZS-HLDS2VT	---	Glass
ZS-HLDS5T	White alumina ceramic	Glass
ZS-HLDS10	White alumina ceramic	---
ZS-HLDS60/HLDS150	White alumina ceramic	---

\*4. This is the value obtained at the measuring center distance when the Sensor and workpiece are fixed by an aluminum jig. (typical example)

\*5. Ask your OMRON representative about Sensor Heads with IP67 protection.

# Ratings and Specifications

## ZS-L-series Sensor Heads

Item	Model	ZS-LD20T	ZS-LD20ST	ZS-LD40T	ZS-LD10GT	ZS-LD15GT			
Applicable Controllers		ZS-HLDC/LDC Series							
Optical system		Regular reflection	Diffuse reflection	Regular reflection	Diffuse reflection	Regular reflection			
Measuring center distance		20 mm	6.3 mm	20 mm	6.3 mm	40 mm	30 mm	10 mm	15 mm
Measuring range		±1 mm	±1 mm	±1 mm	±1 mm	±2.5 mm	±2 mm	±0.5 mm	±0.75 mm
Light source		Visible semiconductor laser (wavelength: 650 nm, 1 mW max., JIS Class 2)							
Beam shape		Line beam		Spot beam		Line beam			
Beam diameter *1		900 × 25 μm		25 μm dia.		2000 × 35 μm		Approx. 25 × 900 μm	
Linearity *2		±0.1% FS							
Resolution *3		0.25 μm		0.25 μm		0.25 μm		0.25 μm	
Temperature characteristic *4		0.04% FS/°C		0.04% FS/°C		0.02% FS/°C		0.04% FS/°C	
Sampling cycle		110 μs (High-speed Mode), 500 μs (Standard Mode), 2.2 ms (High-precision Mode), 4.4 ms (High-sensitivity Mode)							
LED Indicators	NEAR indicator	Lights near the measuring center distance, and closer than the measuring center distance inside the measuring range. Flashes when the measurement target is outside of the measuring range or when the received light amount is insufficient.							
	FAR indicator	Lights near the measuring center distance, and farther than the measuring center distance inside the measuring range. Flashes when the measurement target is outside of the measuring range or when the received light amount is insufficient.							
Operating ambient illumination		Illumination on received light surface: 3000 lx or less (incandescent light)							
Ambient temperature		Operating: 0 to 50°C, Storage: -15 to 60°C (with no icing or condensation)							
Ambient humidity		Operating and storage: 35% to 85% (with no condensation)							
Degree of protection		Cable length 0.5 m: IP66, cable length 2 m: IP67						IP40	
Materials		Case: Aluminum die-cast, Front cover: Glass							
Cable length		0.5 m, 2 m							
Weight		Approx. 350 g						Approx. 400 g	
Accessories		Laser labels (1 each for JIS/EN, 3 for FDA), ferrite cores (2), insure locks (2), instruction sheet						Laser safety labels (1 each for JIS/EN), ferrite cores (2), insure locks (2)	

\*1. Defined as  $1/e^2$  (13.5%) of the center optical intensity at the actual measuring center distance (effective value). The beam diameter is sometimes influenced by the ambient conditions of the workpiece, such as leaked light from the main beam.

\*2. This is the error in the measured value with respect to an ideal straight line. The standard workpiece is white aluminum ceramics and glass in the regular reflection mode. Linearity may change according to the workpiece.

\*3. This is the peak-to-peak displacement conversion value in the displacement output at the measuring center distance in high-precision mode when the number of samples to average is set to 128 and the measuring mode is set to the high-resolution mode.  
The standard workpiece is white aluminum ceramics and glass in the regular reflection mode.

\*4. This is the value obtained at the measuring center distance when the Sensor and workpiece are fixed by an aluminum jig. (typical example)



## Ratings and Specifications

### ZS-L-series Sensor Heads

Item	Model	ZS-LD50	ZS-LD50S	ZS-LD80	ZS-LD130	ZS-LD200	ZS-LD350S					
Applicable Controllers		ZS-HLDC/LDC Series										
Optical system		Diffuse reflection	Regular reflection	Diffuse reflection	Regular reflection	Diffuse reflection	Regular reflection	Diffuse reflection	Regular reflection	Diffuse reflection	Regular reflection	Diffuse reflection
Measuring center distance		50 mm	47 mm	50 mm	47 mm	80 mm	78 mm	130 mm	130 mm	200 mm	200 mm	350 mm
Measuring range		±5 mm	±4 mm	±5 mm	±4 mm	±15 mm	±14 mm	±15 mm	±12 mm	±50 mm	±48 mm	±135 mm
Light source		Visible semiconductor laser (wavelength: 650 nm, 1 mW max., JIS Class 2)										
Beam shape		Line beam		Spot beam		Line beam		Line beam		Line beam		Spot beam
Beam diameter *1		900 × 60 μm		50 μm dia.		900 × 60 μm		600 × 70 μm		900 × 100 μm		240 μm dia.
Linearity *2 ±0.1% FS		±0.1% FS										
Resolution *3		0.8 μm		0.8 μm		2 μm		3 μm		5 μm		20 μm
Temperature characteristic *4		0.02% FS/°C		0.02% FS/°C		0.01% FS/°C		0.02% FS/°C		0.02% FS/°C		0.04% FS/°C
Sampling cycle *5		110 μs (High-speed Mode), 500 μs (Standard Mode), 2.2 ms (High-precision Mode), 4.4 ms (High-sensitivity Mode)										
LED Indicators	NEAR indicator	Lights near the measuring center distance, and closer than the measuring center distance inside the measuring range. Flashes when the measurement target is outside of the measuring range or when the received light amount is insufficient.										
	FAR indicator	Lights near the measuring center distance, and farther than the measuring center distance inside the measuring range. Flashes when the measurement target is outside of the measuring range or when the received light amount is insufficient.										
Operating ambient illumination		Illumination on received light surface: 3000 lx or less (incandescent light)					Illumination on received light surface: 2000 lx or less (incandescent light)		Illumination on received light surface: 3000 lx or less (incandescent light)			
Ambient temperature		Operating: 0 to 50°C, Storage: -15 to 60°C (with no icing or condensation)										
Ambient humidity		Operating and storage: 35% to 85% (with no condensation)										
Degree of protection		Cable length 0.5 m: IP66, cable length 2 m: IP67										
Materials		Case: Aluminum die-cast, Front cover: Glass										
Cable length		0.5 m, 2 m										
Weight		Approx. 350g										
Accessories		Laser labels (1 each for JIS/EN, 3 for FDA), ferrite cores (2), insure locks (2), instruction sheet										

\*1. Defined as  $1/e^2$  (13.5%) of the center optical intensity at the actual measuring center distance (effective value). The beam diameter is sometimes influenced by the ambient conditions of the workpiece, such as leaked light from the main beam.

\*2. This is the error in the measured value with respect to an ideal straight line. The standard workpiece is white aluminum ceramics and glass in the ZS-LD50/LD50S regular reflection mode. Linearity may change according to the workpiece.

\*3. This is the peak-to-peak displacement conversion value in the displacement output at the measuring center distance in high-precision mode when the number of samples to average is set to 128 and the measuring mode is set to the high-resolution mode.  
The standard workpiece is white aluminum ceramics and glass in the ZS-LD50/LD50S regular reflection mode.

\*4. This is the value obtained at the measuring center distance when the Sensor and workpiece are fixed by an aluminum jig.

\*5. This value is obtained when the measuring mode is set to the high-speed mode. (typical example)

# Ratings and Specifications

## ZS-MDC□1 Multi-Controllers

Basic specifications are the same as those for the ZS-LDC□1 Sensor Controllers. The following points, however, are different.

1. Sensor Heads cannot be connected.
2. Control Link Units are required to connect up to 9 Controllers.  
Control Link Units are required to connect Controllers.
3. Processing functions between Controllers: Arithmetic functions

## Controller Link Units

Connection Using the ZS-XCN



## ZS-DSU□1 Data Storage Unit

Item	Model	ZS-DSU11	ZS-DSU41
Number of mounted Sensor Heads		Cannot be connected	
Number of connectable Controllers		10 max. (ZS-MDC: 1, ZS-HLDC/LDC: 9 max.) *1	
Connectable Controllers		ZS-HLDC□□, ZS-LDC□□, ZS-MDC□□	
External interface	Connection method	Serial I/O: connector, Other: pre-wired (standard cable length: 2 m)	
	Serial I/O	USB 2.0	1 port, Full Speed (12 Mbps max.), MINI-B
		RS-232C	1 port, 115,200 bps max.
	Output	3 outputs: HIGH, PASS, and LOW; NPN open-collector, 30 VDC, 50 mA max., residual voltage: 1.2 V max.	3 outputs: HIGH, PASS, and LOW; PNP open-collector, 50 mA max., residual voltage: 1.2 V max.
Inputs	ON: Short-circuited with 0 V terminal or 1.5 V or less; OFF: Open (leakage current: 0.1 mA max.)	ON: Short-circuited to supply voltage or within 1.5 V of supply voltage; OFF: Open (leakage current: 0.1 mA max.)	
Data resolution		32 bits	
Functions	Logging trigger functions	Start and stop triggers can be set separately; external triggers, data triggers (self-triggers), and time triggers	
	Other functions	External banks, alarm outputs, saved data format customization, and clock	
Status indicators		OUT (orange), PWR (green), ACCESS (orange), and ERR (red)	
Segment display		8-segment green LEDs, 6 digits	
LCD		16 digits x 2 rows, Color of characters: green, Resolution per character: 5 x 8 pixel matrix	
Setting inputs	Setting keys	Direction keys (UP, DOWN, LEFT, and RIGHT), SET key, ESC key, MENU key, and function keys (1 to 4)	
	Slide switch	Threshold switch (2 states: High/Low), mode switch (3 states: FUN, TEACH, and RUN)	
Power supply voltage		21.6 V to 26.4 VDC (including ripple)	
Current consumption		0.5 A max.	
Ambient temperature		Operating: 0 to 50°C, Storage: 0 to 60°C (with no icing or condensation)	
Ambient humidity		Operating and storage: 35% to 85% (with no condensation)	
Materials		Case: Polycarbonate (PC)	
Weight		Approx. 280 g (excluding packing materials and accessories)	
Accessories		Ferrite core (1), instruction sheet for Data Storage Unit: CSV File Converter for Data Storage Unit/Smart Analyzer Macro Edition	

\*1. Control Link Units are required to connect Controllers.

## Dimensions

### Sensor Controllers

ZS-HLDC□1/LDC□1



### Multi-Controllers

ZS-MDC□1



### Data Storage Units

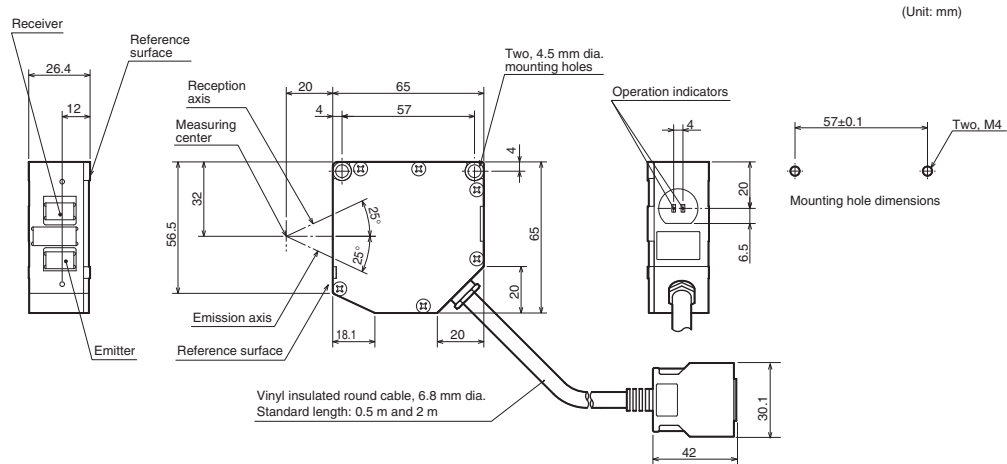
ZS-DSU□1



# Dimensions

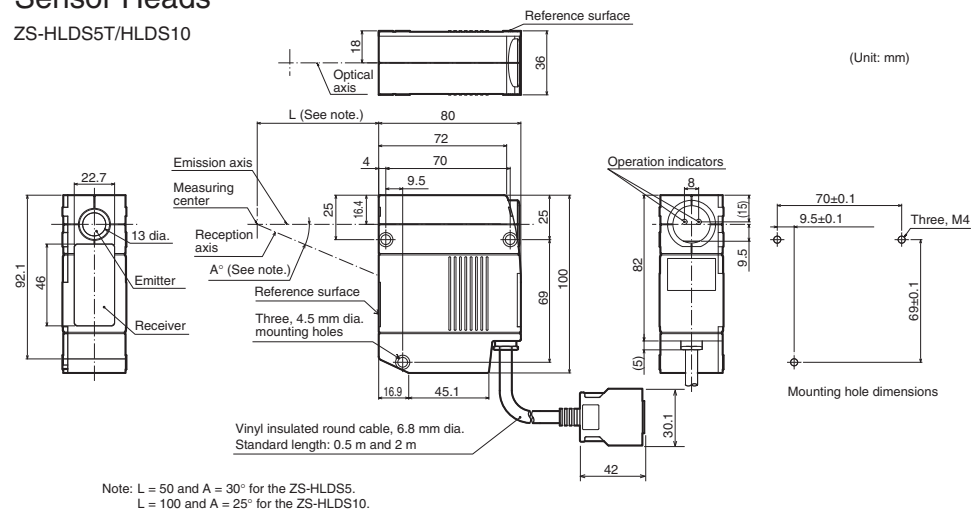
## Sensor Heads

ZS-HLDS2T



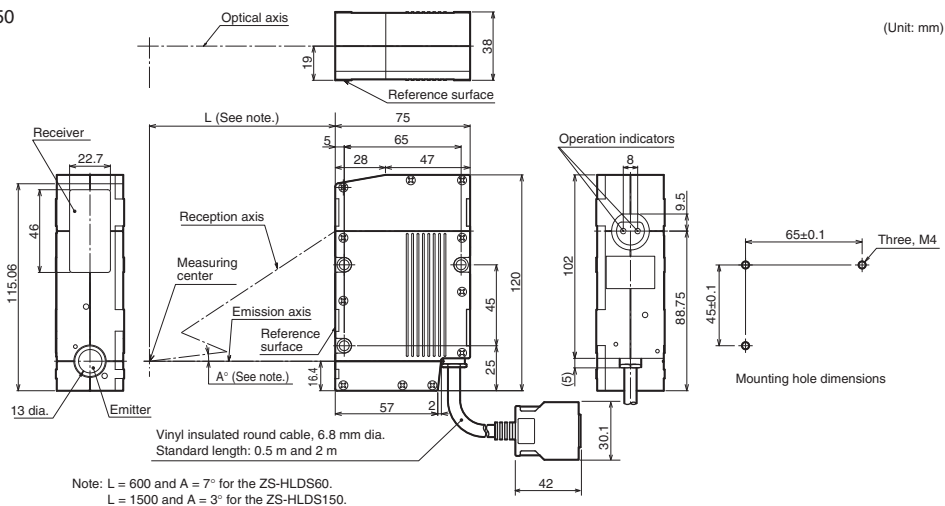
## Sensor Heads

ZS-HLDS5T/HLDS10



## Sensor Heads

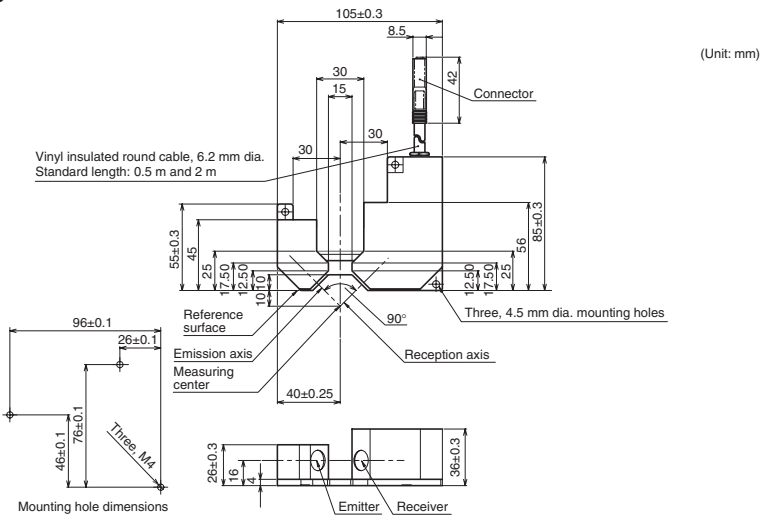
ZS-HLDS60/HLDS150



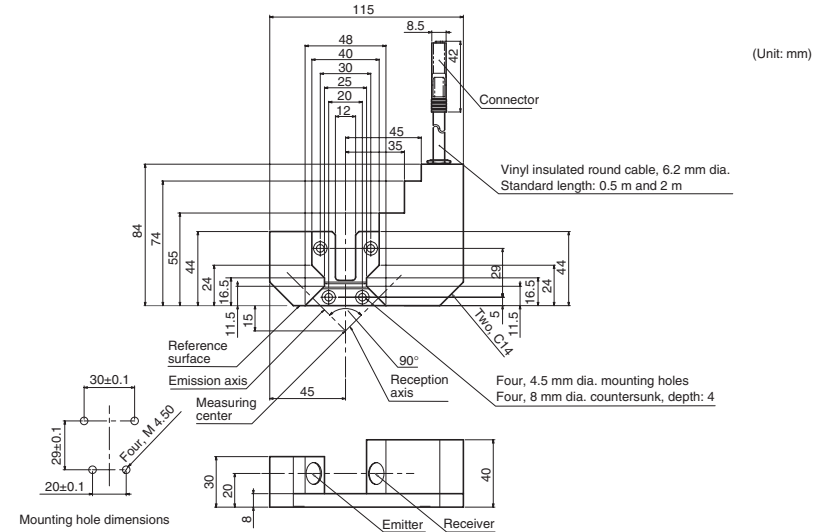
## Dimensions

### Sensor Heads

ZS-LD10GT

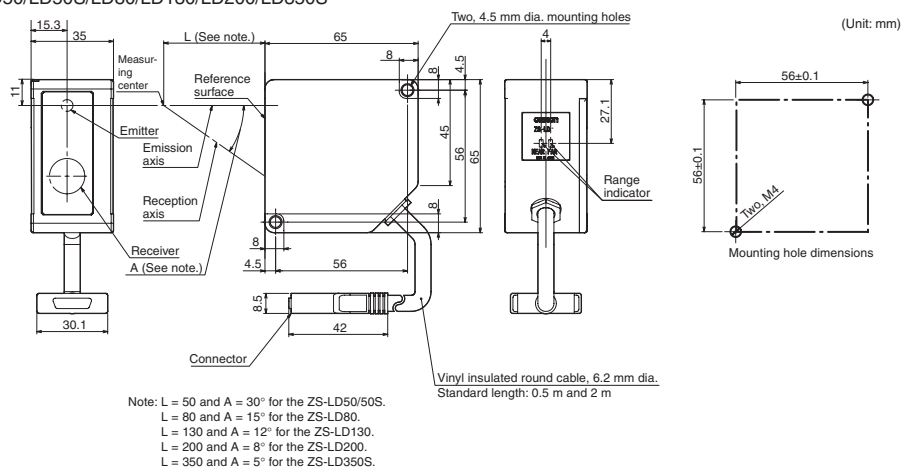


ZS-LD15GT

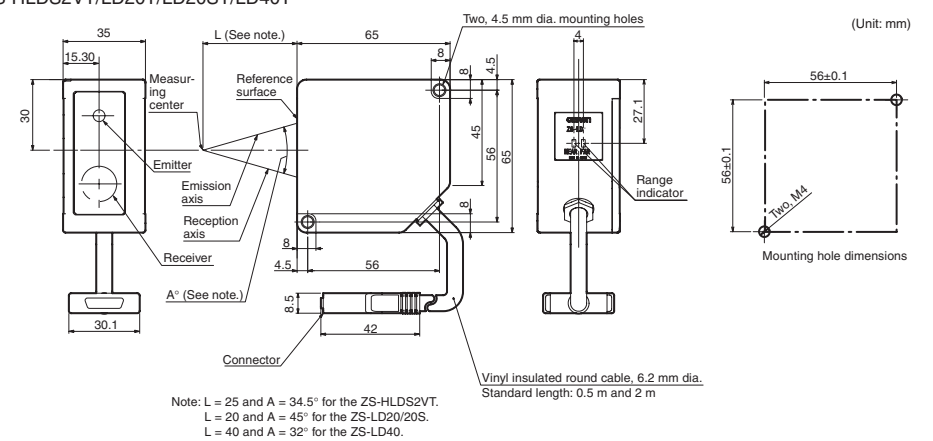


### Sensor Heads

ZS-LD50/LD50S/LD80/LD130/LD200/LD350S



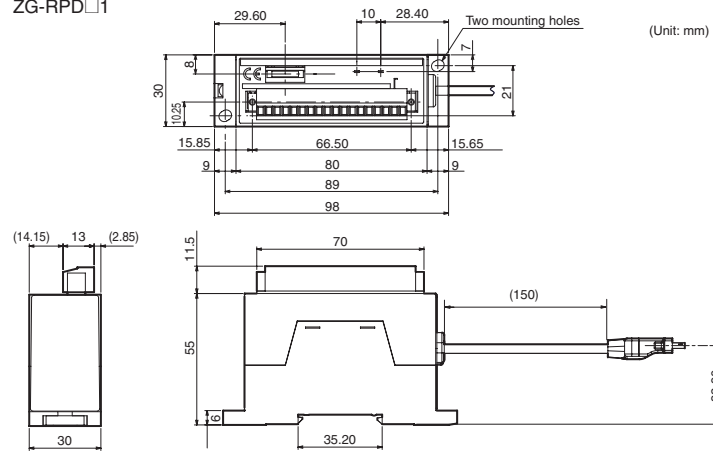
ZS-HLDS2VT/LD20T/LD20ST/LD40T



# Dimensions

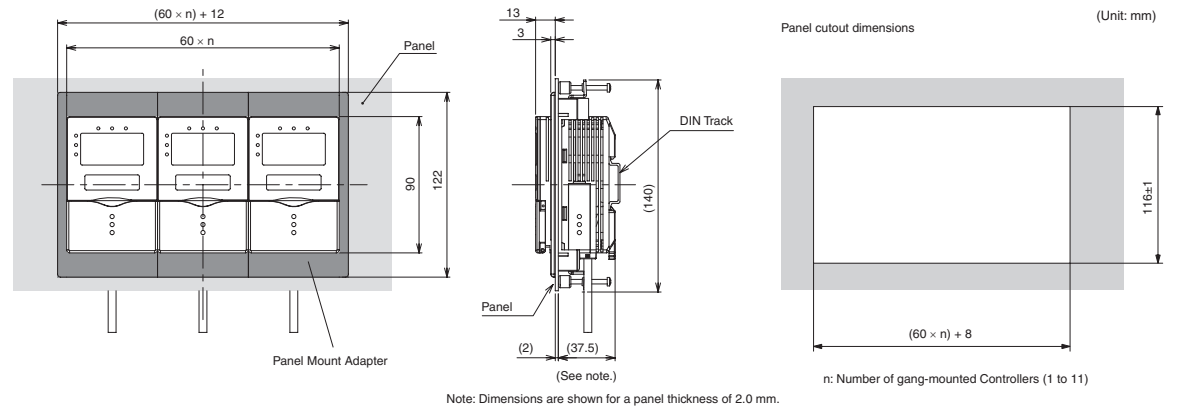
## Realtime Parallel Output Unit

ZG-RPD□1



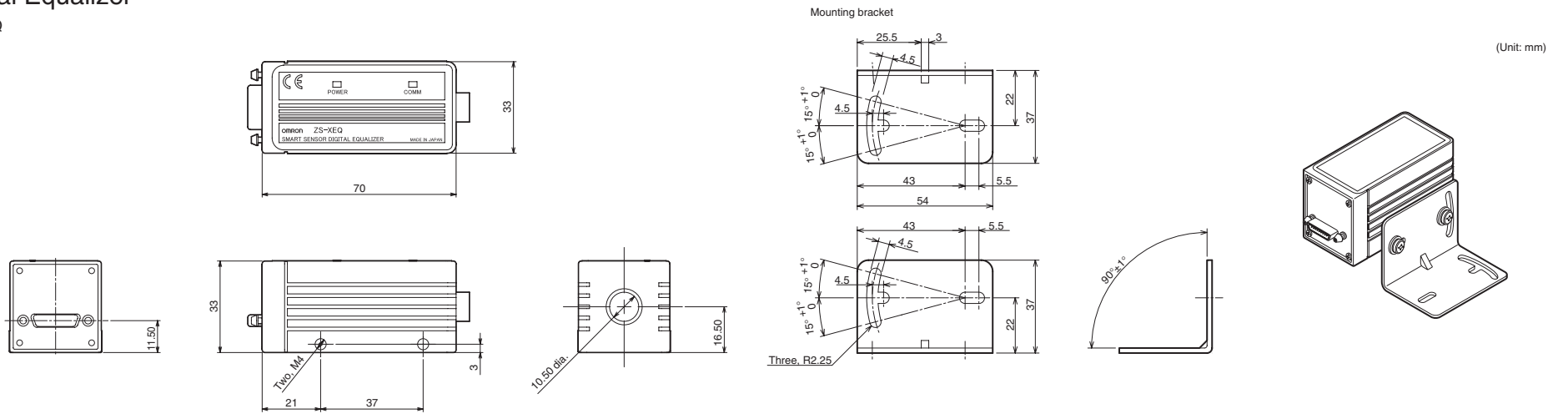
## Panel Mount Adapter

ZS-XPM1/XPM2 (Dimensions for Panel Mounting)



## Digital Equalizer

ZS-XEQ



## Safety Precautions for Using Laser Equipment

**WARNING**

Do not expose your eyes to the laser radiation either directly or indirectly (i.e., after reflection from a mirror or shiny surface). The laser radiation has a high power density and exposure may result in loss of sight.

**Laser Label Indications**

Attach the following warning label to the side of the ZS series Sensor Head.

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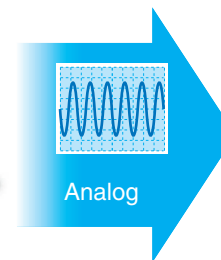
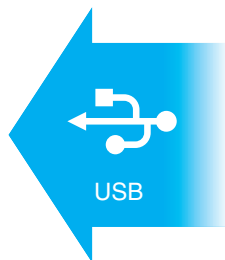
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# A Wide Range of Information Support Tools for Production Lines

## Handheld Types



## Installed Types



**ZR-MDR10 Mobile Data Recorder**  
 The ZR-MDR10 connects to a ZS Smart Sensor via a USB host interface. It lets the operator easily make optimal sensor settings while checking production and sensing conditions on the mobile screen.

**ZP-C Graphic Data Controller**  
 The ZP-C Graphic Data Controller is ideal for connecting to an analog output device such as a ZS-series Displacement Sensor. Touch-panel operation allows the operator to instantly calculate and compare the resulting input signals, and to display them in a numerical or graphic format.

This document provides information mainly for selecting suitable models. Please read the manual carefully for information that the user must understand and accept before purchase, including information on warranty, limitations of liability, and precautions.

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